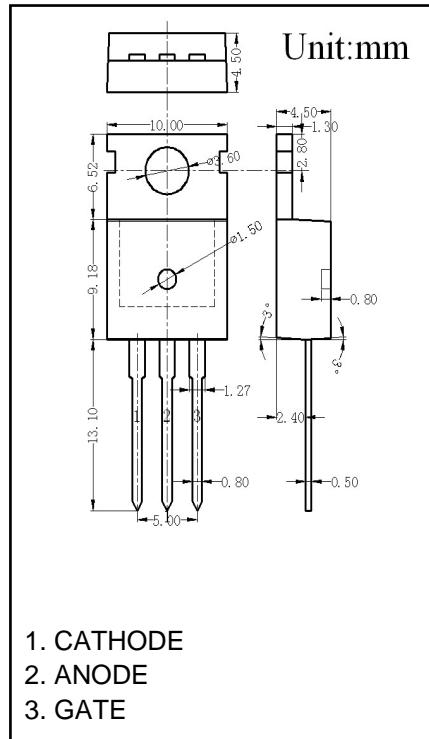
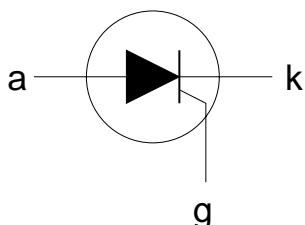


TO-220 Plastic-Encapsulate Thyristors

BT151-650/800

**GENERAL DESCRIPTION**

Glass passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications includ emotor control,industrial and domestic lighting,heating and static switching.


**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
$V_{DRM}$ , $V_{RRM}$	Repetitive peak off-state voltages		-	$-500R$ 500 <sup>1</sup>	$-650R$ 650 <sup>1</sup>	$-800R$ 800	V
$I_{T(AV)}$ $I_{T(RMS)}$ $I_{TSM}$	Average on-state current RMS on-state current Non-repetitive peak on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$ all conduction angles	-	7.5	12		A
$I^2t$ $dI_T/dt$	$I^2t$ for fusing Repetitive rate of rise of on-state current after triggering	half sine wave; $T_j = 25^\circ\text{C}$ prior to surge $t = 10\text{ ms}$ $t = 8.3\text{ ms}$ $t = 10\text{ ms}$ $I_{TM} = 20\text{ A}; I_G = 50\text{ mA};$ $dI_G/dt = 50\text{ mA}/\mu\text{s}$	- - - - -	100	110	50	A A A $\text{A}^2\text{s}$ $\text{A}/\mu\text{s}$
$I_{GM}$ $V_{GM}$ $V_{RGM}$	Peak gate current Peak gate voltage Peak reverse gate voltage		-	2	5	5	A V V
$P_{GM}$ $P_{G(AV)}$	Peak gate power Average gate power	over any 20 ms period	-	5	0.5	0.5	W W
$T_{stg}$ $T_j$	Storage temperature Operating junction temperature		-40 -	150	125	125	$^\circ\text{C}$ $^\circ\text{C}$

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j\text{-}mb}$	Thermal resistance junction to mounting base		-	-	1.3	K/W
$R_{th\ j\text{-}a}$	Thermal resistance junction to ambient	in free air	-	60	-	K/W

## STATIC CHARACTERISTICS

$T_j = 25^\circ\text{C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{GT}$	Gate trigger current	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	-	2	15	mA
$I_L$	Latching current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	-	10	40	mA
$I_H$	Holding current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	-	7	20	mA
$V_T$	On-state voltage	$I_T = 23\text{ A}$	-	1.4	1.75	V
$V_{GT}$	Gate trigger voltage	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	-	0.6	1.5	V
$I_D, I_R$	Off-state leakage current	$V_D = V_{DRM(max)}; I_T = 0.1\text{ A}; T_j = 125^\circ\text{C}$ $V_D = V_{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125^\circ\text{C}$	0.25	0.4	-	V
			-	0.1	0.5	mA

## DYNAMIC CHARACTERISTICS

$T_j = 25^\circ\text{C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$dV_D/dt$	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125^\circ\text{C}$ ; exponential waveform;				
$t_{gt}$	Gate controlled turn-on time	Gate open circuit $R_{GK} = 100\ \Omega$ $I_{TM} = 40\text{ A}; V_D = V_{DRM(max)}; I_G = 0.1\text{ A};$ $dI_G/dt = 5\text{ A}/\mu\text{s}$	50 200	130 1000	- -	V/ $\mu\text{s}$ V/ $\mu\text{s}$
$t_q$	Circuit commutated turn-off time	$V_D = 67\% V_{DRM(max)}; T_j = 125^\circ\text{C};$ $I_{TM} = 20\text{ A}; V_R = 25\text{ V}; dI_{TM}/dt = 30\text{ A}/\mu\text{s};$ $dV_D/dt = 50\text{ V}/\mu\text{s}; R_{GK} = 100\ \Omega$	-	70	-	$\mu\text{s}$

